



## IEEE JRFID Special Issue on IEEE WiSEE 2023

This special issue is intended to promote results presented at the **11th annual IEEE International Conference on Wireless for Space and Extreme Environments (WiSEE 2023)** held on June 6-8, 2023, in Aveiro, Portugal, with more depth and details at the journal article level with archival value. The submitted papers will undergo peer review similar to regular JRFID papers.

The manuscript **must be significantly extended** beyond the scope of the conference paper in terms of the overall technical contents and research results (a similarity percent match less than 30% is mandatory).

**The submission deadline is December 31, 2023.** Nevertheless, submissions in advance with respect to the deadline are strongly encouraged, since the accepted manuscripts will be published as Early Access documents on IEEE Xplore as soon as the final files are submitted by the authors.

### Submission guidelines

The following requirements must be accounted for when submitting the manuscript:

1. The **manuscript must be technically extended** beyond the contents of the conference paper. The novelty aspects with respect to the conference paper must to be properly discussed and highlighted, through the text. Additionally, the authors must provide in the **Cover Letter** detailed information on how the manuscript is a technically-extended version of the conference paper.
2. In the manuscript, the **conference paper must be listed** as one of the references and clearly referred. A **pdf copy of the conference paper** must also be submitted.

The manuscript, together with the accompanying documents (i.e. cover letter, conference paper and IEEE copyright transfer form), must be submitted electronically using the Manuscript Central website <https://mc.manuscriptcentral.com/jrfid>, according to the format available at <https://journals.ieeeauthorcenter.ieee.org/>.

When uploading the manuscript select for your manuscript the following TYPE: **"WiSEE 2023"**. Subsequently, do not forget to **upload both the Cover Letter and the conference paper as "Supplemental Files for Review"**. Failure to follow above request will result in the immediate return of the manuscript to the author(s) as an unacceptable submission. For any questions on the submission process, please contact the Editor-in-Chief of IEEE JRFID, Prof. Paolo Nepa ([paolo.nepa@unipi.it](mailto:paolo.nepa@unipi.it)) or the Guest Editors.

### **Guest Editors:**

**Prof. Alessandra Costanzo** Dept. of Electrical, Electronic and Information Engineering "G. Marconi"  
 Alma Mater Studiorum, University of Bologna, Bologna, Italy  
 ([alessandra.costanzo@unibo.it](mailto:alessandra.costanzo@unibo.it))

**Prof. Jasmin Grosinger** Institute of Microwave and Photonic Engineering, Graz University of Technology,  
 Graz, Austria  
 ([jasmin.grosinger@tugraz.at](mailto:jasmin.grosinger@tugraz.at))

**Dr. Andrea Nardin** Department of Electronics and Telecommunications (DET), Politecnico di Torino,  
 Turin, Italy  
 ([andrea.nardin@polito.it](mailto:andrea.nardin@polito.it))

### IMPORTANT DATES:

**Submission deadline: DECEMBER 31, 2023**    **Publication of the Special Issue: mid 2024**